In the Claims:

Please amend the claims as indicated below. This listing of claims replaces all prior versions.

- 1. (Currently Amended) A hybrid MOS-bipolar device comprising a trench MOS device having at least source, gate, drain and body regions, the gate and base the body being shorted together and biased positively relative to the drain.
- 2. (Currently Amended) The hybrid MOS-bipolar device of claim I wherein said further comprising a gate oxide having has a single oxide thickness of under 600A.
- 3. (Currently Amended) The hybrid MOS-bipolar device of claim 1 wherein said further comprising a gate oxide having has a multiple oxide thicknesses for formation of gate and field-oxide regions.
- 4. (Original) The hybrid MOS-bipolar device of claim 2 having a square trench geometry.
- 5. (Original) The hybrid MOS-bipolar device of claim 2 having a circular geometry.
- 6. (Currently Amended) A method of implementing a hybrid MOS-bipolar device <u>that</u> includes a trench MOS device having a source, <u>a</u> body and <u>a</u> gate, comprising shorting together <u>the</u> body and <u>the</u> gate of a trench MOS device and positively biasing the an electrode connected to the shorted body and gate.
- 7. (Currently Amended) The method of claim 6 wherein the <u>trench MOS device includes a</u> gate oxide <u>having a thickness that</u> varies along the length thereof.

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- 8. (Original) The method of claim 7 wherein the gate oxide thickness varies by having two substantially discrete levels of thickness.
- 9. (Currently Amended) The method of claim 8 wherein said <u>hybrid MOS-bipolar</u> device has a PI region and an Ndrift region, and wherein <u>the gate oxide has</u> a first gate oxide thickness is <u>fabricated</u> adjacent said PI region and a second and thicker gate oxide thickness is <u>fabricated</u> adjacent said Ndrift region.
- 10. (Currently Amended) A hybrid MOS-bipolar device comprising a PI region, an Ndrift region, a body, <u>a</u> gate, <u>a</u> drain and <u>a</u> source, said device being configured with its <u>body</u> base and gate shorted together, said device <u>including having</u> a gate oxide <u>having</u> a thickness of a first value adjacent said PI region[[,]] and <u>having</u> a gate oxide thickness of a second value adjacent said Ndrift region.
- 11. (Original) The hybrid MOS bipolar device of claim 10, wherein said gate and said body are positively biased.
- 12. (Currently Amended) A method of making a hybrid MOS-bipolar device comprising doping a PI region to optimize said region for said MOS device, and fabricating a gate electrode from to optimize a bipolar component of said hybrid MOS-bipolar device.
- 13. (Currently Amended) The method of claim 12 further comprising making a gate oxide <u>having a thickness</u> that varies along the length thereof.
- 14. (Currently Amended) The method of claim 13 wherein said gate oxide thickness is greater in a region adjacent said PI region than it is <u>in a region</u> adjacent said Ndrift region.

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- 15. (Original) The method of claim 14 wherein said device is constructed using a double metal process flow.
- 16. (Currently Amended) A hybrid bipolar-MOS device having comprising a first region serving as a source and <u>an</u> emitter, a second region serving as a body and a base, and a third region serving as a gate and base, the gate and <u>the body</u> base being shorted together and positively biased.
- 17. (Currently Amended) The hybrid bipolar-MOS device of claim 16 having further comprising a fourth region that serves as both a drain and a collector.
- 18. (Currently Amended) The hybrid bipolar-MOS device of claim 17 having wherein the device has a breakdown voltage of approximately 200 volts.
- 19. (Currently Amended) The hybrid bipolar-MOS device of claim 17 <u>further comprising a gate oxide</u> having a single gate oxide thickness of approximately 380-600 <u>Angstroms</u> Angstoms.
- 20. (Currently Amended) The hybrid bipolar-MOS device of claim 17 <u>further comprising a</u> gate oxide having plural gate oxide a plurality of thicknesses.
- 21. (Original) The hybrid MOS-bipolar device of claim 2 having a stripe geometry.
- 22. (New) A hybrid MOS-bipolar device comprising:
- a MOS device having a trench gate, a source, a drain and a body, the trench gate and the body being shorted together and biased positively relative to the drain;
- a bipolar device having an emitter, a collector, a base and a gate formed by the trench gate, the emitter and the source being formed by a common region, the base and the body

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being formed by a common region, and the collector and the drain being formed by a common region;

a substrate that includes a PI region and an N drift region, the trench gate extending from a top surface of the substrate through the PI region into the N drift region;

- a first electrode coupled to the trench gate, the body and the base; and a second electrode coupled to the source and the emitter.
- 23. (New) The device of claim 22, further comprising a gate oxide that insulates the trench gate from the substrate, the gate oxide having a first thickness in a region adjacent the N drift region and having a second thickness adjacent the PI regions, the first thickness being greater than the second thickness.
- 24. (New) The device of claim 22, further comprising a third electrode coupled to the drain and collector, the third electrode located on a bottom surface of the substrate.